

Surface Mount Type TACT Switch[™] > SKRP Series > SKRPADE010

4.2 × 3.2mm Compact High Operating Force Type (Surface Mount) SKRP Series

| <u>Dimensions</u> | <u>Land Dimensions</u> | <u>Circuit Diagram</u> | <u>Packing Specifications</u> |

Soldering Conditions



Part number <u>Series Common Info</u> SKRPADE010

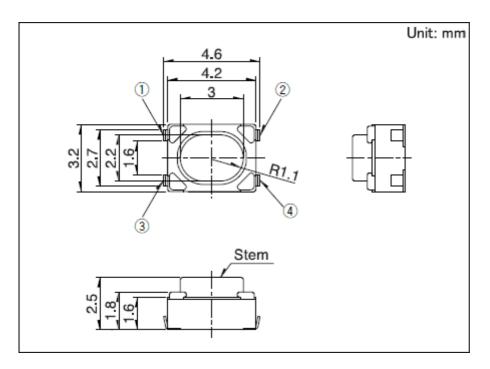


Standard type

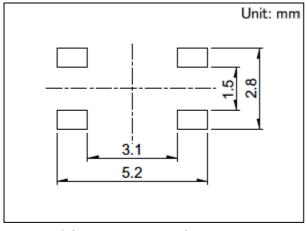
| Туре | Surface mount |
|---------------------------------|--------------------|
| Operating force | 4N |
| Operating direction | Top push |
| Travel | 0.2mm |
| Operating life (50mA 16V DC) | 100,000 cycles |
| Initial contact resistance | 500m Ω max. |

| 7.02.2020 | | SKRP Series - Basic information |
|------------------------------|--------------------------|--|
| Stem color | E | Black |
| Series type | | Sharp feeling type |
| Operating temprange | perature | -30°C to +85°C |
| Rating (max.) | | 50mA 16V DC |
| Rating (min.) | | 10µA 1V DC |
| Electrical performance | Insulation resistance | $100 M\Omega$ min. 100V DC for 1min. |
| | Voltage proof | 250V AC for 1 min. |
| Durability | Vibration | 10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2 hours respectively |
| | Cold | $-30 \pm 2^{\circ}$ C for 96h |
| Environmental performance | Dry heat | $80 \pm 2^{\circ}$ C for 96h |
| | Damp heat | 60±2°C, 90 to 95%RH for 96h |
| Minimum order unit (pcs.) | | Japan 4,000 |
| | | Export 4,000 |

Dimensions

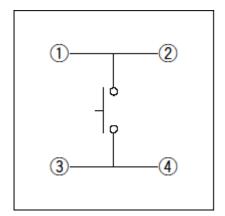


Land Dimensions



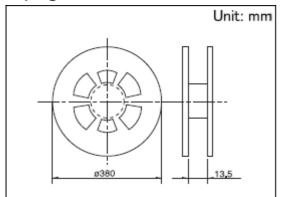
Viewed from mounting face.

Circuit Diagram



Packing Specifications

Taping



| 7.02.2020 | | SKRP Series - Basic information |
|----------------------------------|----------------------------|---------------------------------|
| Number of | 1 reel | 4,000 |
| packages (pcs.) | 1 case / Japan | 40,000 |
| | 1 case / export packing | 40,000 |
| Tape width (mm) | | 12 |
| Export package measurements (mm) | | 395 	imes 395 	imes 205 |

Soldering Conditions

Condition for Reflow

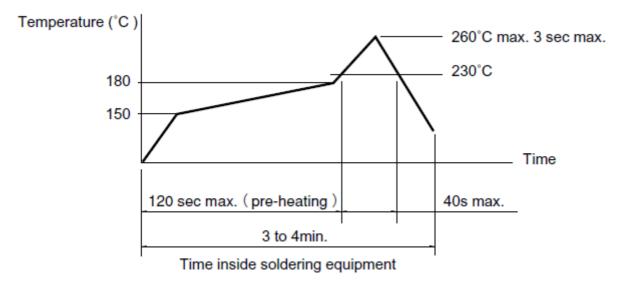
1. Heating method

Double heating method with infrared heater.

2. Temperature measurement

Thermocouple 0.1 to 0.2 Φ CA(K) or CC(T) at solder joints (copper foil surface). A heat resisting tape should be used for fix measurement.

3. Temperature profile



(1) The above temperature shall be measured of the top of switch. There are cases where PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC board's and others. Care, should be taken to prevent the switch's surface temperature from exceeding 260°C.

(2) Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Manual Soldering

ItemsConditionSoldering temperature350°C max.

Duration of soldering 3s max. Capacity of soldering iron60W max.

- 1. Do not washing the TACT Switch^M.
- 2. Prevent flux penetration from the top side of the TACT switch[™].
- 3. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 4. The second soldering should be done after the switch returns to normal temperature.

Notes are common to this series/models.

- 1. This site catalog shows only outline specifications. When using the products, please obtain formal specifications for supply.
- 2. Please place purchase orders for taping products per minimum order unit (1 reel or a case).
- 3. For ϕ 330mm diameter reel requirements, please contact us.

Inquiries about Products

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